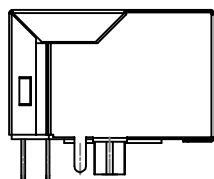


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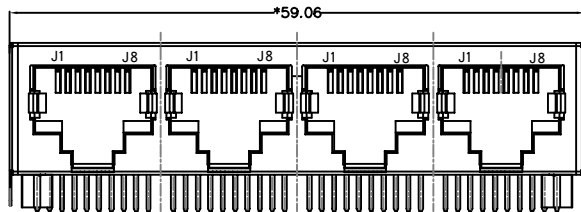
REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	ZG.Hu	2018.06.26



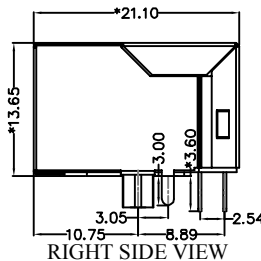
TOP VIEW



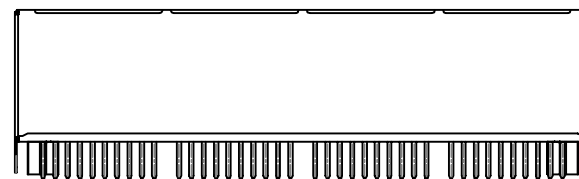
LEFT SIDE VIEW



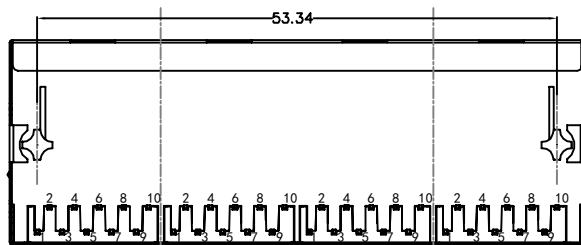
FRONT VIEW



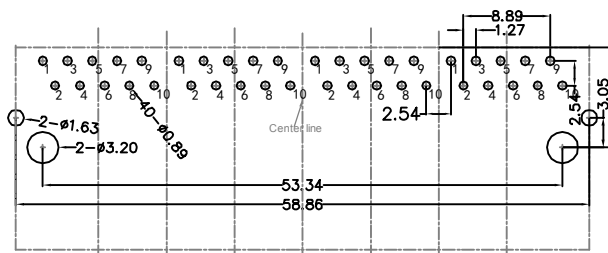
RIGHT SIDE VIEW



BACK VIEW




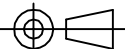
BOTTOM VIEW



RECOMMENDED PCB LAYOUT  
VIEWED FROM COMPONENT SIDE

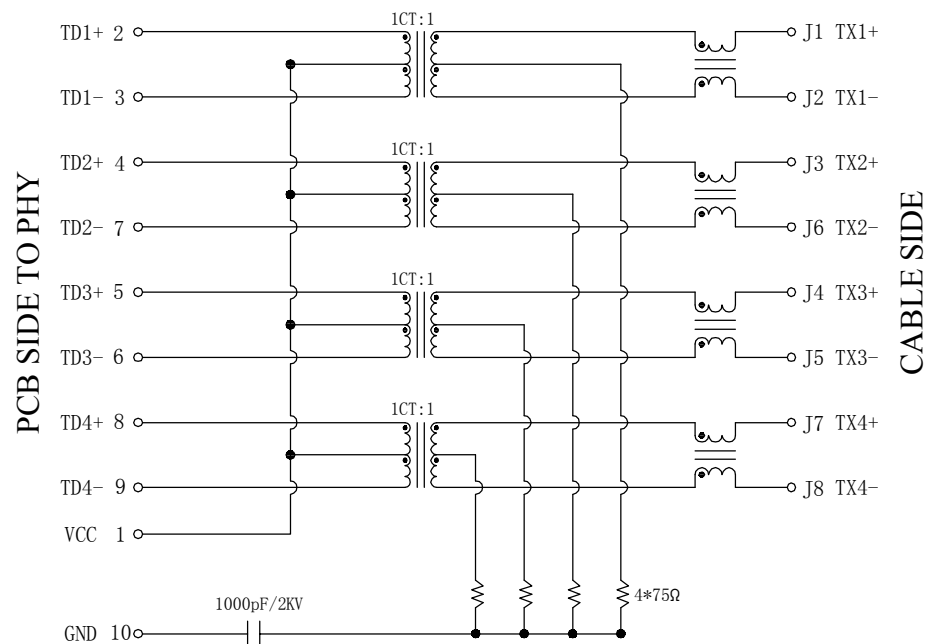
**MATERIAL:**  
HOUSING: PBT,UL94V-0,BLACK.  
TERMINALS BRACKET: PBT,UL94V-0,BLACK.  
SHIELD: C2680,T=0.20MM,NICKEL PLATING ON ALL AREA.  
TERMINAL: PHOSPHOR BRONZE C5210,T=0.35MM,  
6U" GOLD PLATING ON CONTACT AREA.

**MECHANICAL:**  
DURABILITY: 750 CYCLES MIN.  
MATING FORCE: 23N MAX.  
OPERATING TEMPERATURE: -40°C~+85°C.  
STORAGE TEMPERATURE: -40°C~+85°C.  
ALL CRITICAL DIMENSIONS WITH "\*"

 <b>苏州沃虎电子科技有限公司</b> Su Zhou Wo Hu Electronic Tech.Co.,Ltd.	TITLE: TAB-DOWN 1X4 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
	PART NO.: SYT114Q066GWA1D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.Xu
	REMARK:	SHEET 1/3		.xx±0.25	.xx°±1.5°	DESIGND BY: ZG.Hu
				.xxx±0.10	.xxx°±1.0°	

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### Electrical:

- Turn ratio: 2~3: J1~J2=1CT:1CT(±2%).  
4~7: J3~J6=1CT:1CT(±2%).  
5~6: J4~J5=1CT:1CT(±2%).  
8~9: J7~J8=1CT:1CT(±2%).
- OCL: 350uH Min. at 100KHz 100mV 8mA DC.
- Insertion Loss: -1.0 dB Max 1~100MHz.
- Return loss: -18dB Min 1~30MHz;  
-14dB Min 30~60MHz.  
-12dB Min 60~80MHz.  
-10dB Min 80~100MHz.
- Cross talk: -40dB Min 1~30MHz;  
-35dB Min 30~60MHz;  
-30dB Min 60~100MHz;
- CMR: -30dB Min 1~100MHz;
- Hi-Pot: 2250V DC 6S 1mA PRI TO SEC

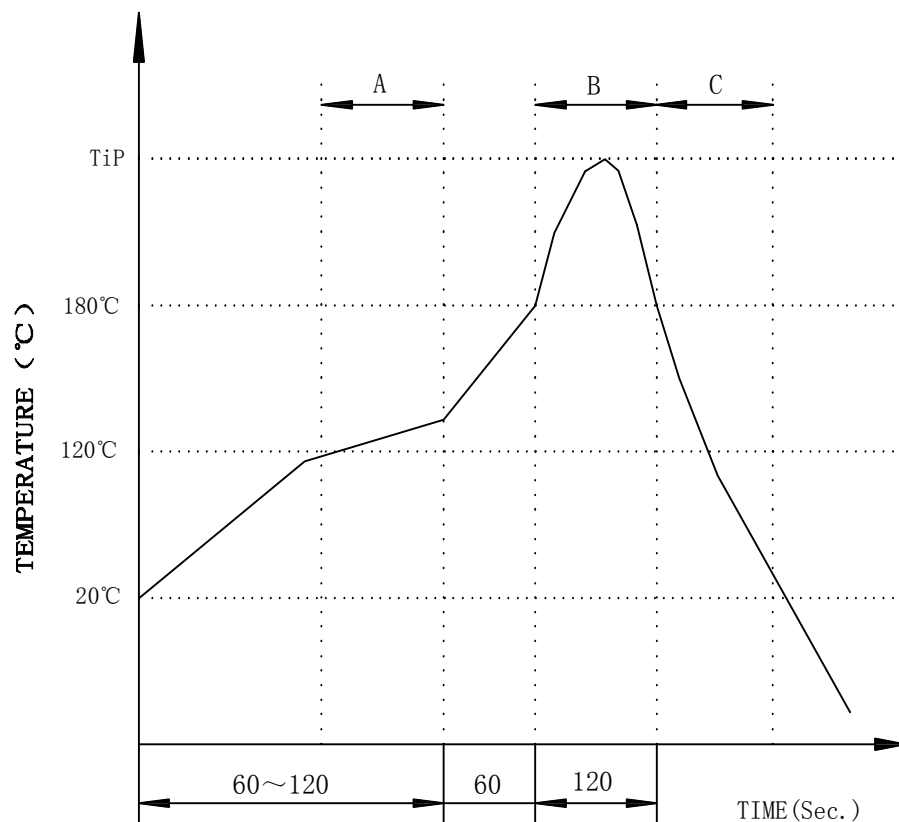


TITLE: TAB-DOWN 1X4 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: SYT114Q066GWA1D	SACLE 1:1	REV A0	x±0.35 .x±0.30	x°±3.0° .x°±2.0°	CHECKED BY: TW.Xu
REMARK:	SHEET 2/3		.xx±0.25 .xxx±0.10	.xx°±1.5° .xxx°±1.0°	DESIGN BY: ZG.Hu

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# PROFILE OF WAVE SOLDER

REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	ZG.Hu	2018.06.26



A.Preheating B.Soldering C.Gradual Cooling  
 Tip temperature:260±5°C.  
 Tip temperature time:5Sec Max.  
 Tip melting point of Sn96.5/Ag3/Cu0.5:217°C.

Remarks: after wave soldering, the plastic positioning columns of the product which under the PCB will be slightly melted, but it won't affect its function.

**WOHU** 苏州沃虎电子科技有限公司  
 Su Zhou Wo Hu Electronic Tech.Co.,Ltd.

TITLE: TAB-DOWN 1X4 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: SYT114Q066GWA1D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.Xu
REMARK:	SHEET 3/3		.xx±0.25	.xx°±1.5°	DESIGND BY: ZG.Hu
			.xxx±0.10	.xxx°±1.0°	